

Altera Device Package Information

04R-00332-1.0

1152-Pin Hybrid FineLine Ball-Grid Array (HBGA) - Flip Chip - Dual-Piece Lid - A:3.70

- All dimensions and tolerances conform to ASME Y14.5M 1994.
- Controlling dimension is in millimeters.
- Pin A1 may be indicated by an ID dot, or a special feature, in its proximity on package surface.

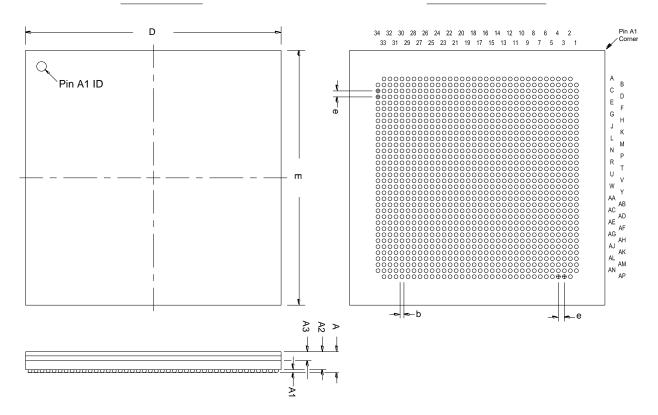
| Package Information | | |
|----------------------------|---|--|
| Description | Specification | |
| Ordering Code Reference | Н | |
| Package Acronym | HBGA | |
| Substrate Material | ВТ | |
| Solder ball composition | Regular: 63Sn:37Pb (Typ.) Pb-free: Sn:3Ag:0.5Cu (Typ.) | |
| JEDEC Outline Reference | MS-034 Variation: AAV-1 | |
| Lead Coplanarity | 0.010 inch (0.25 mm) | |
| Weight | 20.2 g (Typ.) | |
| Moisture Sensitivity Level | Printed on moisture barrier bag | |

| Package Outline Dimension Table | | | | |
|---------------------------------|-------------|------|------|--|
| Oh. a.l. | Millimeters | | | |
| Symbol | Min. | Nom. | Max. | |
| Α | 3.30 | 3.50 | 3.70 | |
| A1 | 0.40 | 0.50 | 0.60 | |
| A2 | 2.70 | 3.00 | 3.30 | |
| А3 | 1.40 | 1.50 | 1.60 | |
| D | 42.50 BSC | | | |
| E | 42.50 BSC | | | |
| b | 0.50 | 0.60 | 0.70 | |
| е | 1.00 BSC | | | |

Package Outline

TOP VIEW

BOTTOM VIEW



Document Revision History

Table 1 shows the revision history for this document.

Table 1. Document Revision History

| Date | Version | Changes |
|-----------|---------|-----------------|
| June 2011 | 1.0 | Initial release |



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